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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	13
Program Memory Size	896B (512 x 14)
Program Memory Type	OTP
EEPROM Size	
RAM Size	80 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 6V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	18-SOIC (0.295", 7.50mm Width)
Supplier Device Package	18-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c620-04-so

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4.2.2 SPECIAL FUNCTION REGISTERS

The Special Function Registers are registers used by the CPU and Peripheral functions for controlling the desired operation of the device (Table 4-1). These registers are static RAM. The Special Function Registers can be classified into two sets (core and peripheral). The Special Function Registers associated with the "core" functions are described in this section. Those related to the operation of the peripheral features are described in the section of that peripheral feature.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR Reset	Value on all other RESETS ⁽¹⁾
Bank 0											
00h	INDF	Addressin register)	ig this locat	on uses co	ntents of FS	SR to addre	ess data me	mory (not a	a physical	XXXX XXXX	XXXX XXXX
01h	TMR0	Timer0 Mo	odule's Reg	ister						xxxx xxxx	uuuu uuuu
02h	PCL	Program (Counter's (F	PC) Least S	Significant B	yte				0000 0000	0000 0000
03h	STATUS	IRP ⁽²⁾	RP1 ⁽²⁾	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
04h	FSR	Indirect da	ata memory	address po	ointer					xxxx xxxx	uuuu uuuu
05h	PORTA	—	—	—	RA4	RA3	RA2	RA1	RA0	x 0000	u 0000
06h	PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	xxxx xxxx	uuuu uuuu
07h-09h	Unimplemented									_	_
0Ah	PCLATH	—	—	—	Write buffe	er for upper	5 bits of pr	ogram coui	nter	0 0000	0 0000
0Bh	INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	—	CMIF	—	—	—	—	—	—	-0	-0
0Dh-1Eh	Unimplemented									_	_
1Fh	CMCON	C2OUT	C10UT	—	—	CIS	CM2	CM1	CM0	00 0000	00 0000
Bank 1											
80h	INDF	Addressin register)	g this locat	ion uses co	ntents of FS	SR to addre	ess data me	mory (not a	a physical	xxxx xxxx	xxxx xxxx
81h	OPTION	RBPU	INTEDG	TOCS	TOSE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
82h	PCL	Program (Counter's (F	PC) Least S	ignificant B	yte				0000 0000	0000 0000
83h	STATUS	IRP ⁽²⁾	RP1 ⁽²⁾	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
84h	FSR	Indirect da	ata memory	address po	ointer					xxxx xxxx	uuuu uuuu
85h	TRISA	-	-	—	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	1 1111	1 1111
86h	TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	1111 1111	1111 1111
87h-89h	Unimplemented									_	_
8Ah	PCLATH	-	-	—	Write buffe	er for upper	5 bits of pr	ogram coui	nter	0 0000	0 0000
8Bh	INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000u
8Ch	PIE1	—	CMIE	—	—	—	—	—	—	-0	-0
8Dh	Unimplemented									_	_
8Eh	PCON	_	_	_	_	—	_	POR	BOR	0x	uq
8Fh-9Eh	Unimplemented								-	_	_
9Fh	VRCON	VREN	VROE	VRR	_	VR3	VR2	VR1	VR0	000- 0000	000- 0000

TABLE 4-1: SPECIAL REGISTERS FOR THE PIC16C62X

Legend: — = Unimplemented locations read as '0', u = unchanged, x = unknown,

 ${\rm q}$ = value depends on condition, shaded = unimplemented

Note 1: Other (non Power-up) Resets include MCLR Reset, Brown-out Reset and Watchdog Timer Reset during normal operation.

2: IRP & RP1 bits are reserved; always maintain these bits clear.

4.2.2.1 STATUS Register

The STATUS register, shown in Register 4-1, contains the arithmetic status of the ALU, the RESET status and the bank select bits for data memory.

The STATUS register can be the destination for any instruction, like any other register. If the STATUS register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the TO and PD bits are not writable. Therefore, the result of an instruction with the STATUS register as destination may be different than intended.

For example, CLRF STATUS will clear the upper-three bits and set the Z bit. This leaves the STATUS register as 000uuluu (where u = unchanged).

It is recommended, therefore, that only BCF, BSF, SWAPF and MOVWF instructions are used to alter the STATUS register, because these instructions do not affect any STATUS bit. For other instructions not affecting any STATUS bits, see the "Instruction Set Summary".

- Note 1: The IRP and RP1 bits (STATUS<7:6>) are not used by the PIC16C62X and should be programmed as '0'. Use of these bits as general purpose R/W bits is NOT recommended, since this may affect upward compatibility with future products.
 - 2: The <u>C and DC bits</u> operate as a Borrow and Digit Borrow out bit, respectively, in subtraction. See the SUBLW and SUBWF instructions for examples.

REGISTER 4-1: STATUS REGISTER (ADDRESS 03H OR 83H)

Reserved	Reserved	R/W-0	R-1	R-1	R/W-x	R/W-x	R/W-x
IRP	RP1	RP0	TO	PD	Z	DC	С
bit 7	•						bit 0
IRP: Regis	ster Bank Sele	ect bit (used	d for indirect	addressing)		
1 = Bank 2	2, 3 (100h - 1F	FFh)					
0 = Bank (The IRP hi), 1 (UUN - FFI it is reserved	n) on the PIC:	16C62X alw	/avs maintai	in this hit cle	ar	
RP<1·0>	Register Banl	C Select hits	s (used for c	lirect addres	sina)		
01 = Bank	1 (80h - FFh)			Joinig)		
00 = Bank	0 (00h - 7Fh))					
Each bank	is 128 bytes.	The RP1 b	oit is reserve	ed on the Pl	C16C62X; a	lways maint	ain this bit
clear.							
IU: Time-o			tion of at t	I Dinatruati	~ ~		
1 = Alter p 0 = A WD1	ower-up, сък Г time-out осо	curred		EP Instructi	on		
PD: Power	r-down bit						
1 = After p	ower-up or by	/ the CLRWI	DT instructio	n			
0 = By exe	ecution of the	SLEEP inst	ruction				
Z: Zero bit							
1 = The re	sult of an ariti	hmetic or lo	gic operatio	n is zero	`		
	orry/borrow b) instructions)(for borrow)	the polarity
is reversed	any/bonow b 1)	IL (ADDWF ,	ADDLW, SU	вым, зовиг	Instructions		the polarity
1 = A carry	/-out from the	4th low or	der bit of the	result occu	rred		
0 = No car	ry-out from th	e 4th low o	rder bit of th	ie result			
C: Carry/borrow bit (ADDWF, ADDLW, SUBLW, SUBWF instructions)							
1 = A carry-out from the Most Significant bit of the result occurred							
0 = 100 carry-out from the Most Significant bit of the result occurred							
Note: For porrow the polarity is reversed. A subtraction is executed by adding the two's complement of the second operand. For rotate (REFRLF) instructions, this bit is							
	loaded with e	ither the high	gh or low or	der bit of the	e source reg	ister.	o, and bit lo
Legend:							
R = Reada	able bit	VV = VV	ritable bit	U = Unin	nplemented	bit, read as	'0'
- n = Value	e at POR	'1' = Bi	t is set	'0' = Bit i	s cleared	x = Bit is u	nknown
	Reserved IRP bit 7 IRP: Regis 1 = Bank 2 0 = Bank 0 The IRP bit RP<1:0>: 01 = Bank 0 RP<1:0>: 01 = Bank 0 Bank 0 RP<1:0>: 01 = Bank 0 RP<1:0>: 01 = Bank 0 RP<1:0>: 0 = Bank 0 I = After p 0 = A WD1 PD: Power 1 = After p 0 = By exee Z: Zero bit 1 = The re 0 = The re DC: Digit c is reversed 1 = A carry 0 = No car C: Carry/b 1 = A carry 0 = No car Note: Legend: R = Reada - n = Value	ReservedReservedIRPRP1bit 7IRP: Register Bank Sele1 = Bank 2, 3 (100h - 1f0 = Bank 0, 1 (00h - FFIThe IRP bit is reservedRP<1:0>: Register Bank01 = Bank 1 (80h - FFh)00 = Bank 0 (00h - 7Fh)Each bank is 128 bytes.clear.TO: Time-out bit1 = After power-up, CLR0 = A WDT time-out occPD: Power-down bit1 = After power-up or by0 = By execution of theZ: Zero bit1 = The result of an arith0 = The result of an arith0 = The result of an arith0 = No carry-out from the0 = No carry-out from the1 = A carry-out from the0 = No carry-out from the0 = No carry-out from the1 = A carry-out from the0 = No carry-out from the0 = No carry-out from the0 = No carry-out from the1 = A carry out from the1 = A carry out from the<	ReservedRevolR/W-0IRPRP1RP0bit 7IRP: Register Bank Select bit (used1 = Bank 2, 3 (100h - 1FFh)0 = Bank 0, 1 (00h - FFh)The IRP bit is reserved on the PIC? RP<1:0> : Register Bank Select bits01 = Bank 1 (80h - FFh)00 = Bank 0 (00h - 7Fh)Each bank is 128 bytes. The RP1 bitclear. TO : Time-out bit1 = After power-up, CLRWDT instruct0 = A WDT time-out occurred PD : Power-down bit1 = After power-up or by the CLRWD0 = By execution of the SLEEP inst Z : Zero bit1 = The result of an arithmetic or lo0 = The result of an arithmetic or lo0 = The result of an arithmetic or lo0 = C: Digit carry/borrow bit (ADDWF, is reversed)1 = A carry-out from the 4th low or0 = No carry-out from the Most Signi0 = No carry-out from the Most Signi <td>ReservedR/W-0R-1IRPRP1RP0TObit 7IRP: Register Bank Select bit (used for indirect1 = Bank 2, 3 (100h - 1FFh)0 = Bank 0, 1 (00h - FFh)The IRP bit is reserved on the PIC16C62X; alwRP<1:0>: Register Bank Select bits (used for d)01 = Bank 1 (80h - FFh)00 = Bank 0 (00h - 7Fh)Each bank is 128 bytes. The RP1 bit is reservedclear.TO: Time-out bit1 = After power-up, CLRWDT instruction, or SLE0 = A WDT time-out occurredPD: Power-down bit1 = After power-up or by the CLRWDT instructio0 = By execution of the SLEEP instructionZ: Zero bit1 = The result of an arithmetic or logic operatio0 = C: Digit carry/borrow bit (ADDWF, ADDLW, SUD)is reversed)1 = A carry-out from the 4th low order bit of the0 = No carry-out from the Most Significant bit of0 = No carry-out from the Most Significant bit of0 = No carry-out from the Most Significant bit of0 = No carry-out from the Most Significant bit of0 = No carry-out from the Most Significant bit of0 = No carry-out from the Most Significant bit of0 = No carry-out from the Most Significant bit of0 = No carry-out from the Most Significant bit of0 = No carry-out from the Most Significant bit of0 = No carry-out from the Most Significant bit of0 = No carry-out from the Most Significant bit of0 = No carry-out from the Most Significant bit of0 = No carry-out from the Most Significant bit of0 = No carry-</td> <td>Reserved Revol R-1 R-1 R-1 IRP RP1 RP0 TO PD bit 7 IRP: Register Bank Select bit (used for indirect addressing 1 = Bank 2, 3 (100h - 1FFh) 0 = Bank 0, 1 (00h - FFh) The IRP bit is reserved on the PIC16C62X; always maintait RP<1:0>: Register Bank Select bits (used for direct address 01 = Bank 1 (80h - FFh) 00 = Bank 0 (00h - 7Fh) Each bank is 128 bytes. The RP1 bit is reserved on the PIC clear. TO: Time-out bit 1 = After power-up, CLRWDT instruction, or SLEEP instruction 0 = A WDT time-out occurred PD: Power-down bit 1 = After power-up or by the CLRWDT instruction 0 = By execution of the SLEEP instruction 2: Zero bit 1 = The result of an arithmetic or logic operation is zero 0 = The result of an arithmetic or logic operation is not zero DC: Digit carry/borrow bit (ADDWF, ADDLW, SUBLW, SUBWF is reversed) 1 = A carry-out from the 4th low order bit of the result occur 0 = No carry-out from the Most Significant bit of the result of 0 = No carry-out from the Most Significant bit of the result of 0 = No carry-out from the Most Significant bit of the result of 0 = No carry-out from the Most Significant bit of the result of 0 = No carry-out from the Most Significant bit of the result of 0 = No carry-out from the Most Significant bit of the result of 0 = No carry-out from the Most Significant bit of the result of 0 = No carry-out from the Most Significant bit of the result of 0 =</td> <td>Reserved Reserved R/W-0 R-1 R-1 R/W-x IRP RP1 RP0 TO PD Z bit 7 IRP: Register Bank Select bit (used for indirect addressing) 1 = Bank 2, 3 (100h - 1FFh) 0 = Bank 0, 1 (00h - FFh) The IRP bit is reserved on the PIC16C62X; always maintain this bit cle RP<1:0>: Register Bank Select bits (used for direct addressing) 01 = Bank 1 (80h - FFh) 0 = Bank 0 (00h - 7Fh) Each bank is 128 bytes. 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RP<1:0>: Register Bank Select bits (used for direct addressing) 01 = Bank 1 (80h - FFh) 00 Bank 0 (00h - 7Fh) Each bank is 128 bytes. The RP1 bit is reserved on the PIC16C62X; always maintain thicear. TO: Time-out bit 1 After power-up, CLRWDT instruction, or SLEEP instruction 0 0 = A WDT time-out occurred PD: Power-down bit 1 1 = After power-up or by the CLRWDT instruction 0 = By execution of the SLEEP instruction 2: Zero bit 1 The result of an arithmetic or logic operation is zero 0 1 = The result of an arithmetic or logic operation is not zero DC DC D: Digit carry/borrow bit (ADDWF, ADDLW, SUBLW, SUBWF instructions)(for borrow is reversed) 1 A carry-out from the 4th low order bit of the result occurred 0 No carry-out from the Most Significant bit of the result occurred <

Name	Bit #	Buffer Type	Function
RB0/INT	bit0	TTL/ST ⁽¹⁾	Input/output or external interrupt input. Internal software programmable weak pull-up.
RB1	bit1	TTL	Input/output pin. Internal software programmable weak pull-up.
RB2	bit2	TTL	Input/output pin. Internal software programmable weak pull-up.
RB3	bit3	TTL	Input/output pin. Internal software programmable weak pull-up.
RB4	bit4	TTL	Input/output pin (with interrupt-on-change). Internal software programmable weak pull-up.
RB5	bit5	TTL	Input/output pin (with interrupt-on-change). Internal software programmable weak pull-up.
RB6	bit6	TTL/ST ⁽²⁾	Input/output pin (with interrupt-on-change). Internal software programmable weak pull-up. Serial programming clock pin.
RB7	bit7	TTL/ST ⁽²⁾	Input/output pin (with interrupt-on-change). Internal software programmable weak pull-up. Serial programming data pin.

TABLE 5-3: PORTB FUNCTIONS

Legend: ST = Schmitt Trigger, TTL = TTL input

Note 1: This buffer is a Schmitt Trigger input when configured as the external interrupt.

2: This buffer is a Schmitt Trigger input when used in Serial Programming mode.

TABLE 5-4: SUMMARY OF REGISTERS ASSOCIATED WITH PORTB

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on All Other RESETS
06h	PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	XXXX XXXX	uuuu uuuu
86h	TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	1111 1111	1111 1111
81h	OPTION	RBPU	INTEDG	TOCS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111

Legend: u = unchanged, x = unknown

Note 1: Shaded bits are not used by PORTB.

NOTES:

7.4 Comparator Response Time

Response time is the minimum time, after selecting a new reference voltage or input source, before the comparator output has a valid level. If the internal reference is changed, the maximum delay of the internal voltage reference must be considered when using the comparator outputs. Otherwise the maximum delay of the comparators should be used (Table 12-2).

7.5 Comparator Outputs

The comparator outputs are read through the CMCON register. These bits are read only. The comparator outputs may also be directly output to the RA3 and RA4 I/O pins. When the CM<2:0> = 110, multiplexors in the output path of the RA3 and RA4 pins will switch and the output of each pin will be the unsynchronized output of the comparator. The uncertainty of each of the comparators is related to the input offset voltage and the response time given in the specifications. Figure 7-3 shows the comparator output block diagram.

The TRISA bits will still function as an output enable/ disable for the RA3 and RA4 pins while in this mode.

- Note 1: When reading the PORT register, all pins configured as analog inputs will read as a '0'. Pins configured as digital inputs will convert an analog input according to the Schmitt Trigger input specification.
 - 2: Analog levels on any pin that is defined as a digital input may cause the input buffer to consume more current than is specified.

FIGURE 7-3: COMPARATOR OUTPUT BLOCK DIAGRAM



9.0 SPECIAL FEATURES OF THE CPU

Special circuits to deal with the needs of real-time applications are what sets a microcontroller apart from other processors. The PIC16C62X family has a host of such features intended to maximize system reliability, minimize cost through elimination of external components, provide power saving operating modes and offer code protection.

These are:

- 1. OSC selection
- 2. RESET Power-on Reset (POR) Power-up Timer (PWRT) Oscillator Start-up Timer (OST) Brown-out Reset (BOR)
- 3. Interrupts
- 4. Watchdog Timer (WDT)
- 5. SLEEP
- 6. Code protection
- 7. ID Locations
- 8. In-Circuit Serial Programming™

The PIC16C62X devices have a Watchdog Timer which is controlled by configuration bits. It runs off its own RC oscillator for added reliability. There are two timers that offer necessary delays on power-up. One is the Oscillator Start-up Timer (OST), intended to keep the chip in RESET until the crystal oscillator is stable. The other is the Power-up Timer (PWRT), which provides a fixed delay of 72 ms (nominal) on power-up only, designed to keep the part in RESET while the power supply stabilizes. There is also circuitry to RESET the device if a brown-out occurs, which provides at least a 72 ms RESET. With these three functions on-chip, most applications need no external RESET circuitry.

The SLEEP mode is designed to offer a very low current Power-down mode. The user can wake-up from SLEEP through external RESET, Watchdog Timer wake-up or through an interrupt. Several oscillator options are also made available to allow the part to fit the application. The RC oscillator option saves system cost, while the LP crystal option saves power. A set of configuration bits are used to select various options.

9.2.3 EXTERNAL CRYSTAL OSCILLATOR CIRCUIT

Either a prepackaged oscillator can be used or a simple oscillator circuit with TTL gates can be built. Prepackaged oscillators provide a wide operating range and better stability. A well-designed crystal oscillator will provide good performance with TTL gates. Two types of crystal oscillator circuits can be used; one with series resonance or one with parallel resonance.

Figure 9-3 shows implementation of a parallel resonant oscillator circuit. The circuit is designed to use the fundamental frequency of the crystal. The 74AS04 inverter performs the 180° phase shift that a parallel oscillator requires. The 4.7 k Ω resistor provides the negative feedback for stability. The 10 k Ω potentiometers bias the 74AS04 in the linear region. This could be used for external oscillator designs.

FIGURE 9-3: EXTERNAL PARALLEL RESONANT CRYSTAL OSCILLATOR CIRCUIT



Figure 9-4 shows a series resonant oscillator circuit. This circuit is also designed to use the fundamental frequency of the crystal. The inverter performs a 180° phase shift in a series resonant oscillator circuit. The 330 k Ω resistors provide the negative feedback to bias the inverters in their linear region.

FIGURE 9-4: EXTERNAL SERIES RESONANT CRYSTAL OSCILLATOR CIRCUIT



9.2.4 RC OSCILLATOR

For timing insensitive applications the "RC" device option offers additional cost savings. The RC oscillator frequency is a function of the supply voltage, the resistor (REXT) and capacitor (CEXT) values, and the operating temperature. In addition to this, the oscillator frequency will vary from unit to unit due to normal process parameter variation. Furthermore, the difference in lead frame capacitance between package types will also affect the oscillation frequency, especially for low CEXT values. The user also needs to take into account variation due to tolerance of external R and C components used. Figure 9-5 shows how the R/C combination is connected to the PIC16C62X. For REXT values below 2.2 k Ω , the oscillator operation may become unstable or stop completely. For very high REXT values (e.g., 1 M Ω), the oscillator becomes sensitive to noise, humidity and leakage. Thus, we recommend to keep REXT between 3 k Ω and 100 k Ω .

Although the oscillator will operate with no external capacitor (CEXT = 0 pF), we recommend using values above 20 pF for noise and stability reasons. With no or small external capacitance, the oscillation frequency can vary dramatically due to changes in external capacitances, such as PCB trace capacitance or package lead frame capacitance.

See Section 13.0 for RC frequency variation from part to part due to normal process variation. The variation is larger for larger R (since leakage current variation will affect RC frequency more for large R) and for smaller C (since variation of input capacitance will affect RC frequency more).

See Section 13.0 for variation of oscillator frequency due to VDD for given REXT/CEXT values, as well as frequency variation due to operating temperature for given R, C and VDD values.

The oscillator frequency, divided by 4, is available on the OSC2/CLKOUT pin, and can be used for test purposes or to synchronize other logic (Figure 3-2 for waveform).

FIGURE 9-5: RC OSCILLATOR MODE



9.3 RESET

The PIC16C62X differentiates between various kinds of RESET:

- a) Power-on Reset (POR)
- b) MCLR Reset during normal operation
- c) MCLR Reset during SLEEP
- d) WDT Reset (normal operation)
- e) WDT wake-up (SLEEP)
- f) Brown-out Reset (BOR)

Some registers are not affected in any RESET condition Their status is unknown on POR and unchanged in any other RESET. Most other registers are reset to a "RESET state" on Power-on Reset,

MCLR Reset, WDT Reset and MCLR Reset during SLEEP. They are not affected by a WDT wake-up, since this is viewed as the resumption of normal operation. TO and PD bits are set or cleared differently in different RESET situations as indicated in Table 9-2. These bits are used in software to determine the nature of the RESET. See Table 9-5 for a full description of RESET states of all registers.

A simplified block diagram of the on-chip RESET circuit is shown in Figure 9-6.

The $\overline{\text{MCLR}}$ Reset path has a noise filter to detect and ignore small pulses. See Table 12-5 for pulse width specification.





9.4 Power-on Reset (POR), Power-up Timer (PWRT), Oscillator Start-up Timer (OST) and Brown-out Reset (BOR)

9.4.1 POWER-ON RESET (POR)

The on-chip POR circuit holds the chip in RESET until VDD has reached a high enough level for proper operation. To take advantage of the POR, just tie the MCLR pin through a resistor to VDD. This will eliminate external RC components usually needed to create Power-on Reset. A maximum rise time for VDD is required. See Electrical Specifications for details.

The POR circuit does not produce an internal RESET when VDD declines.

When the device starts normal operation (exits the RESET condition), device operating parameters (voltage, frequency, temperature, etc.) must be met to ensure operation. If these conditions are not met, the device must be held in RESET until the operating conditions are met.

For additional information, refer to Application Note AN607, "Power-up Trouble Shooting".

9.4.2 POWER-UP TIMER (PWRT)

The Power-up Timer provides a fixed 72 ms (nominal) time-out on power-up only, from POR or Brown-out Reset. The Power-up Timer operates on an internal RC oscillator. The chip is kept in RESET as long as PWRT is active. The PWRT delay allows the VDD to rise to an acceptable level. A configuration bit, PWRTE can disable (if set) or enable (if cleared or programmed) the Power-up Timer. The Power-up Timer should always be enabled when Brown-out Reset is enabled.

The Power-up Time delay will vary from chip-to-chip and due to VDD, temperature and process variation. See DC parameters for details.

9.4.3 OSCILLATOR START-UP TIMER (OST)

The Oscillator Start-Up Timer (OST) provides a 1024 oscillator cycle (from OSC1 input) delay after the PWRT delay is over. This ensures that the crystal oscillator or resonator has started and stabilized.

The OST time-out is invoked only for XT, LP and HS modes and only on Power-on Reset or wake-up from SLEEP.

9.4.4 BROWN-OUT RESET (BOR)

The PIC16C62X members have on-chip Brown-out Reset circuitry. A configuration bit, BODEN, can disable (if clear/programmed) or enable (if set) the Brown-out Reset circuitry. If VDD falls below 4.0V refer to VBOR parameter D005 (VBOR) for greater than parameter (TBOR) in Table 12-5. The brown-out situation will RESET the chip. A RESET won't occur if VDD falls below 4.0V for less than parameter (TBOR).

On any RESET (Power-on, Brown-out, Watchdog, etc.) the chip will remain in RESET until VDD rises above BVDD. The Power-up Timer will now be invoked and will keep the chip in RESET an additional 72 ms.

If VDD drops below BVDD while the Power-up Timer is running, the chip will go back into a Brown-out Reset and the Power-up Timer will be re-initialized. Once VDD rises above BVDD, the Power-Up Timer will execute a 72 ms RESET. The Power-up Timer should always be enabled when Brown-out Reset is enabled. Figure 9-7 shows typical Brown-out situations.



FIGURE 9-7: BROWN-OUT SITUATIONS

9.4.5 TIME-OUT SEQUENCE

On power-up the time-out sequence is as follows: First PWRT time-out is invoked after POR has expired. Then OST is activated. The total time-out will vary based on oscillator configuration and <u>PWRTE</u> bit status. For example, in RC mode with <u>PWRTE</u> bit erased (<u>PWRT</u> disabled), there will be no time-out at all. Figure 9-8, Figure 9-9 and Figure 9-10 depict time-out sequences.

Since the time-outs occur from the POR pulse, if $\overline{\text{MCLR}}$ is kept low long enough, the time-outs will expire. Then bringing $\overline{\text{MCLR}}$ high will begin execution immediately (see Figure 9-9). This is useful for testing purposes or to synchronize more than one PIC16C62X device operating in parallel.

Table 9-4 shows the RESET conditions for some special registers, while Table 9-5 shows the RESET conditions for all the registers.

9.4.6 POWER CONTROL (PCON)/ STATUS REGISTER

The power control/STATUS register, PCON (address 8Eh), has two bits.

Bit0 is $\overline{\text{BOR}}$ (Brown-out). $\overline{\text{BOR}}$ is unknown on Poweron Reset. It must then be set by the user and checked on subsequent RESETS to see if $\overline{\text{BOR}} = 0$, indicating that a brown-out has occurred. The $\overline{\text{BOR}}$ STATUS bit is a don't care and is not necessarily predictable if the brown-out circuit is disabled (by setting BODEN bit = 0 in the Configuration word).

Bit1 is POR (Power-on Reset). It is a '0' on Power-on Reset and unaffected otherwise. The user must write a '1' to this bit following a Power-on Reset. On a subsequent RESET, if POR is '0', it will indicate that a Power-on Reset must have occurred (VDD may have gone too low).

Oscillator Configuration	Powe	er-up	Brown-out Reset	Wake-up	
	PWRTE = 0	PWRTE = 1	Brown out Rooot	from SLEEP	
XT, HS, LP	72 ms + 1024 Tosc	1024 Tosc	72 ms + 1024 Tosc	1024 Tosc	
RC	72 ms	_	72 ms	_	

TABLE 9-1: TIME-OUT IN VARIOUS SITUATIONS

	TABLE 9-2 :	STATUS/PCON BITS AND THEIR SIGNIFICANCE
--	--------------------	---

POR	BOR	то	PD	
0	Х	1	1	Power-on Reset
0	Х	0	Х	Illegal, TO is set on POR
0	Х	Х	0	Illegal, PD is set on POR
1	0	Х	Х	Brown-out Reset
1	1	0	u	WDT Reset
1	1	0	0	WDT Wake-up
1	1	u	u	MCLR Reset during normal operation
1	1	1	0	MCLR Reset during SLEEP

Legend: u = unchanged, x = unknown

TABLE 9-3: SUMMARY OF REGISTERS ASSOCIATED WITH BROWN-OUT

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR Reset	Value on all other RESETS ⁽¹⁾
83h	STATUS				TO	PD				0001 1xxx	000q quuu
8Eh	PCON	_	_				_	POR	BOR	0x	uq

Legend: u = unchanged, x = unknown, - = unimplemented bit, reads as '0', q = value depends on condition.

Note 1: Other (non Power-up) Resets include MCLR Reset, Brown-out Reset and Watchdog Timer Reset during normal operation.

PIC16C62X

FIGURE 9-11: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP) Vdd Vdd D R R1 MCLR PIC16C62X С Note 1: External Power-on Reset circuit is required only if VDD power-up slope is too slow. The diode D helps discharge the capacitor quickly when VDD powers down. **2:** < 40 k Ω is recommended to make sure that voltage drop across R does not violate the device's electrical specification. **3:** R1 = 100Ω to 1 k Ω will limit any current flowing into MCLR from external capacitor C in the event of MCLR/VPP pin

breakdown due to Electrostatic Discharge (ESD) or Electrical Overstress (EOS).

FIGURE 9-12: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 1



- Note 1: This circuit will activate RESET when VDD goes below (Vz + 0.7V) where Vz = Zener voltage.
 - **2:** Internal Brown-out Reset circuitry should be disabled when using this circuit.

FIGURE 9-13: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 2



3: Resistors should be adjusted for the characteristics of the transistor.

FIGURE 9-14: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 3



This brown-out protection circuit employs Microchip Technology's MCP809 microcontroller supervisor. The MCP8XX and MCP1XX families of supervisors provide push-pull and open collector outputs with both high and low active RESET pins. There are 7 different trip point selections to accommodate 5V and 3V systems.

9.5.1 RB0/INT INTERRUPT

External interrupt on RB0/INT pin is edge triggered, either rising if INTEDG bit (OPTION<6>) is set, or falling, if INTEDG bit is clear. When a valid edge appears on the RB0/INT pin, the INTF bit (INTCON<1>) is set. This interrupt can be disabled by clearing the INTE control bit (INTCON<4>). The INTF bit must be cleared in software in the interrupt service routine before reenabling this interrupt. The RB0/INT interrupt can wake-up the processor from SLEEP, if the INTE bit was set prior to going into SLEEP. The status of the GIE bit decides whether or not the processor branches to the interrupt vector following wake-up. See Section 9.8 for details on SLEEP and Figure 9-18 for timing of wakeup from SLEEP through RB0/INT interrupt.

9.5.2 TMR0 INTERRUPT

An overflow (FFh \rightarrow 00h) in the TMR0 register will set the T0IF (INTCON<2>) bit. The interrupt can be enabled/disabled by setting/clearing T0IE (INTCON<5>) bit. For operation of the Timer0 module, see Section 6.0.

9.5.3 PORTB INTERRUPT

An input change on PORTB <7:4> sets the RBIF (INTCON<0>) bit. The interrupt can be enabled/disabled by setting/clearing the RBIE (INTCON<4>) bit. For operation of PORTB (Section 5.2).

Note:	If a change on the I/O pin should occur
	when the read operation is being executed
	(start of the Q2 cycle), then the RBIF
	interrupt flag may not get set.

9.5.4 COMPARATOR INTERRUPT

See Section 7.6 for complete description of comparator interrupts.



FIGURE 9-16: INT PIN INTERRUPT TIMING

10.0 INSTRUCTION SET SUMMARY

Each PIC16C62X instruction is a 14-bit word divided into an OPCODE which specifies the instruction type and one or more operands which further specify the operation of the instruction. The PIC16C62X instruction set summary in Table 10-2 lists **byte-oriented**, **bitoriented**, and **literal and control** operations. Table 10-1 shows the opcode field descriptions.

For **byte-oriented** instructions, 'f' represents a file register designator and 'd' represents a destination designator. The file register designator specifies which file register is to be used by the instruction.

The destination designator specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the W register. If 'd' is one, the result is placed in the file register specified in the instruction.

For **bit-oriented** instructions, 'b' represents a bit field designator which selects the number of the bit affected by the operation, while 'f' represents the number of the file in which the bit is located.

For **literal and control** operations, 'k' represents an eight or eleven bit constant or literal value.

TABLE 10-1: OPCODE FIELD DESCRIPTIONS

Field	Description
f	Register file address (0x00 to 0x7F)
W	Working register (accumulator)
b	Bit address within an 8-bit file register
k	Literal field, constant data or label
х	Don't care location (= 0 or 1) The assembler will generate code with $x = 0$. It is the recommended form of use for compatibility with all Microchip software tools.
d	Destination select; d = 0: store result in W, d = 1: store result in file register f. Default is d = 1
label	Label name
TOS	Top of Stack
PC	Program Counter
PCLAT H	Program Counter High Latch
GIE	Global Interrupt Enable bit
WDT	Watchdog Timer/Counter
ТО	Time-out bit
PD	Power-down bit
dest	Destination either the W register or the specified regis- ter file location
[]	Options
()	Contents
\rightarrow	Assigned to
<>	Register bit field
∈	In the set of
italics	User defined term (font is courier)

The instruction set is highly orthogonal and is grouped into three basic categories:

- Byte-oriented operations
- **Bit-oriented** operations
- Literal and control operations

All instructions are executed within one single instruction cycle, unless a conditional test is true or the program counter is changed as a result of an instruction. In this case, the execution takes two instruction cycles with the second cycle executed as a NOP. One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1 μ s. If a conditional test is true or the program counter is changed as a result of an instruction, the instruction execution time is 2 μ s.

Table 10-1 lists the instructions recognized by the MPASM $^{\rm TM}$ assembler.

Figure 10-1 shows the three general formats that the instructions can have.

Note:	To maintain upward compatibility with
	future PICmicro [®] products, <u>do not use</u> the
	OPTION and TRIS instructions.

All examples use the following format to represent a hexadecimal number:

0xhh

where h signifies a hexadecimal digit.

FIGURE 10-1: GENERAL FORMAT FOR INSTRUCTIONS



BTFSS	Bit Test f, Skip if Set	CALL	Call Subroutine
Syntax:	[<i>label</i>]BTFSS f,b	Syntax:	[<i>label</i>] CALL k
Operands:	$0 \leq f \leq 127$	Operands:	$0 \leq k \leq 2047$
Operation:	0 ≤ b < 7 skip if (f) = 1 None	Operation:	(PC)+ 1→ TOS, k → PC<10:0>, (PCLATH<4:3>) → PC<12:11>
Encoding:	01 11bb bfff ffff	Status Affected:	None
Description:	If bit 'b' in register 'f' is '1' then the	Encoding:	10 Okkk kkkk kkkk
	next instruction is skipped. If bit 'b' is '1', then the next instruc- tion fetched during the current instruction execution, is discarded and a NOP is executed instead, making this a two-cycle instruction.	Description:	Call Subroutine. First, return address (PC+1) is pushed onto the stack. The eleven bit immedi- ate address is loaded into PC bits <10:0>. The upper bits of the PC are loaded from PCLATH. CALL is
Words:	1		a two-cycle instruction.
Cycles:	1(2)	Words:	1
Example	HERE BTFSS FLAG,1	Cycles:	2
	TRUE • DE •	Example	HERE CALL THER E
	Before Instruction PC = address HERE After Instruction if FLAG<1> = 0, PC = address FALSE if FLAG<1> = 1, PC = address TBUE		PC = Address HERE After Instruction PC = Address THERE TOS = Address HERE+1
	IC- address TRUE	CLRF	Clear f
		Syntax:	[<i>label</i>] CLRF f
		Operands:	$0 \le f \le 127$
		Operation:	$\begin{array}{l} 00h \rightarrow (f) \\ 1 \rightarrow Z \end{array}$
		Status Affected:	Z
		Encoding:	00 0001 1fff ffff
		Description:	The contents of register 'f' are cleared and the Z bit is set.
		Words:	1
		Cycles:	1
		Example	CLRF FLAG_REG
			Before Instruction FLAG_REG = 0x5A After Instruction FLAG_REG = 0x00 Z = 1

NOTES:



FIGURE 12-4: PIC16C62XA VOLTAGE-FREQUENCY GRAPH, $-40^{\circ}C \le Ta \le 0^{\circ}C$, $+70^{\circ}C \le Ta \le +125^{\circ}C$



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PART NO.	<u>-xx</u>	¥	<u>/xx</u>	xxx	E	xamples:
Device	Frequency Range	Temperature Range	Package	Pattern	a)	 PIC16C621A - 04/P 301 = Commercial temp PDIP package, 4 MHz, normal VDD limits, QT pattern #301.
Device Frequency Range	PIC16C6 PIC16C6 PIC16C6 PIC16LC PIC16LC PIC16LC PIC16LC PIC16LC PIC16CF PIC16CF PIC16CC PIC16LC 04 200 04 4 M 20 20 M	52X: VDD range 3.0 52X: VDD range 3.0 52XA: VDD range 3.0 52XA: VDD range 2.5 562XA: VDD range 2.5 572XA: VD range	/ to 6.0V // to 6.0V (Tape 0V to 5.5V 0V to 5.5V (Taj 5V to 6.0V .5V to 6.0V (Taj .5V to 5.5V 2.5V to 5.5V 2.5V to 5.5V 2.5V to 5.5V 2.5V to 5.5V 2.5V to 5.5V 2.0V to 5.5V 2.0V to 5.5V (Taj .5V to 5.5V .5V to 5.5V (Taj .5V to 5.5V)	e and Reel) be and Reel) be and Reel) ape and Reel) ape and Reel) Tape and Reel))	 PIC16LC622- 04I/SO = Industrial temp., SOI package, 200 kHz, extended VDD limits.
emperature Range	e - = I = E =	0°C to +70°C -40°C to +85°C -40°C to +125°C				
Package	P = SO = SS = JW* =	PDIP SOIC (Gull Wing, SSOP (209 mil) Windowed CERD	, 300 mil body) NP			
Pattern	3-Digit Pa	attern Code for QTF	Optimize (blank otherwise)	se)		

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